揭开DCDC EMI中Layout的"神秘面纱"

JonnyJi ang 姜彦旻
Field Application Engineer, MPS北中国区
(特别鸣谢 Francesc Estragues)

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 - Symmetrical input capacitors
 - Splitting ground planes
 - Having copper under the inductor
 - · Shielded inductors
- 4. Conclusions



Introduction

In many seminars we are presented with a suite of techniques to improve the Electro-Magnetic Compatibility (EMC) of our designs.

These techniques don't often come with accurate A to B comparisons to evaluate if they are true, or "quantify" the impact of a particular implementation.

EMC is a very "design specific" topic, there are general physics laws that always apply, but things that are good for a particular design may not be optimal for a different one.

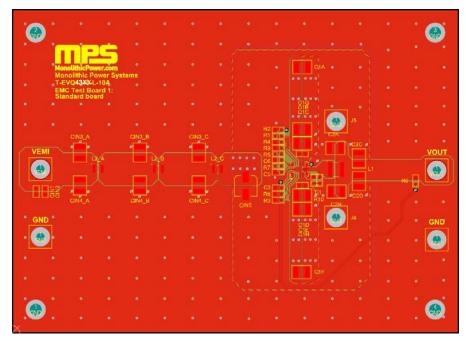
This presentation shows our efforts at trying to myth bust some of the most common EMC tips given in seminars.



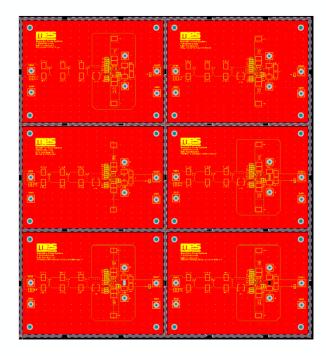


Methodology

In order to accurately study the effect of each individual design technique we have designed a set of PCB that share a similar layout but each featuring a specific change.



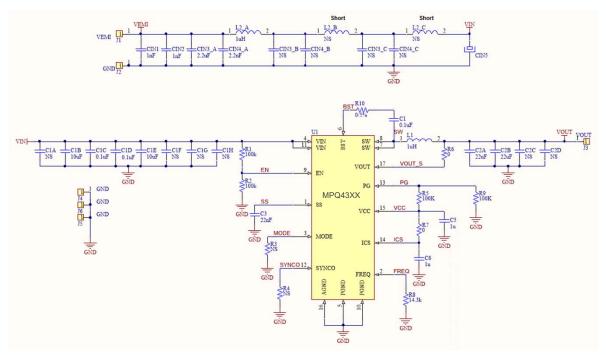
Standard Reference PCB





Methodology

All PCB share the same schematics, but in some cases the components were populated in different footprints.

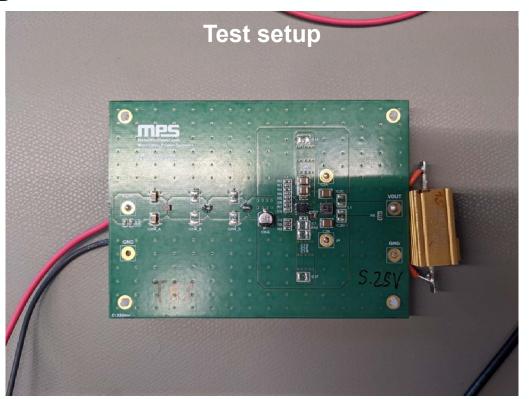


Standard Reference Schematics



Methodology

The input harness follows CISPR25 standard. The output resistor is connected with short cables to the PCB





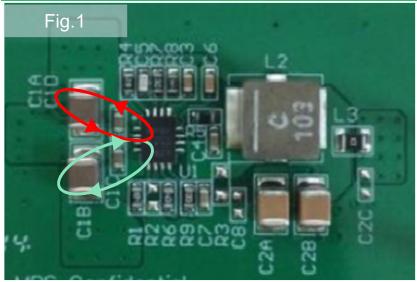
Myth EMC Techniques

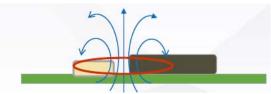
Symmetrical input capacitors

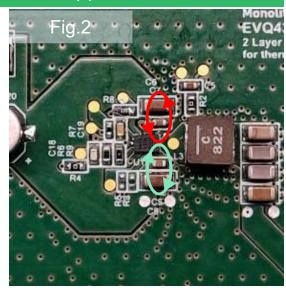


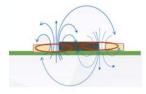
Symmetric Input Capacitors: What is the *myth* about?

When placing the input capacitors symmetrically, creating 2 opposing current loops, the magnetic fields created by the dl/dt cancel each other as they have opposite directions.



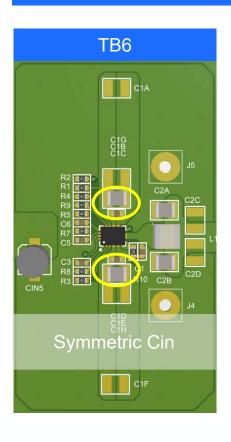


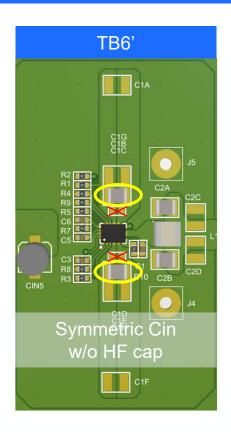


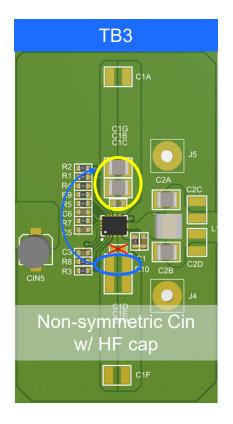


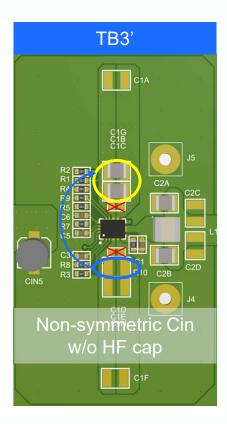


Symmetric Input Capacitors: How was it tested?





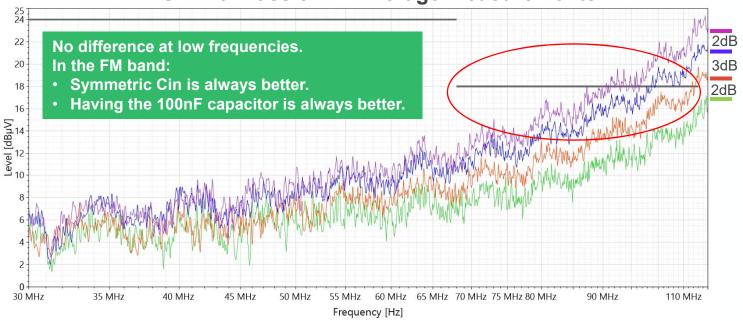


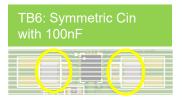


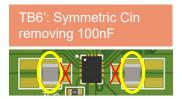


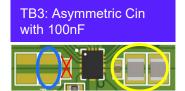
Symmetric Input Capacitors: Test results

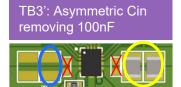








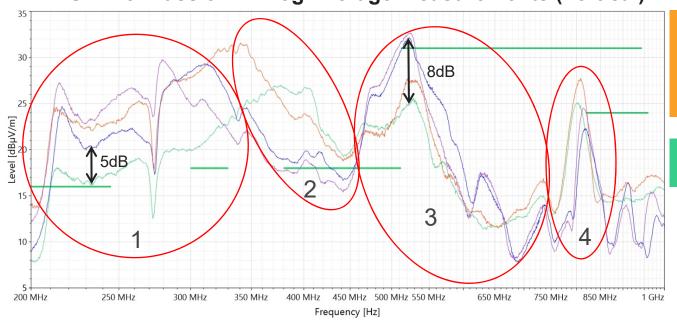






Symmetric Input Capacitors: Test results

CISPR25 Class 5: RE Log Average measurements (Vertical)

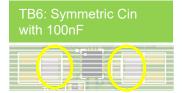


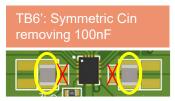
In 1 and 3 the symmetric Cin is ~8dB better.

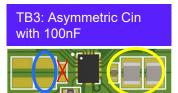
In 2 the symmetric Cin is ~8dB worse.

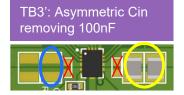
In 4 it is ~3dB worse.

The 100nF capacitor is always better.











Symmetric Input Capacitors: Mythbusting

- The symmetrical input capacitors help improve the EMI in the critical FM band for the Conducted Emissions test.
- In the Radiated Emissions test, they improve the emissions in most bands, while in others they degrade the performance. This is probably due to the decrease of the parasitic L, which moves the resonances to higher frequencies.
- The 100nF capacitors are helpful in almost all frequencies.
- The more problematic bands for the symmetrical capacitors can be improved by other methods like using a Ferrite bead or the next topics.





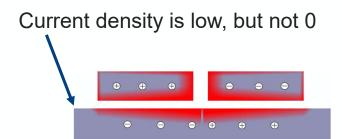
Myth EMC Techniques

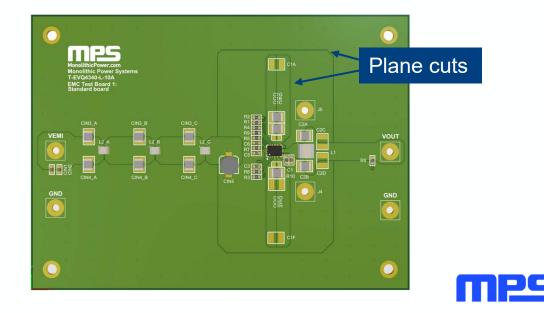
Splitting ground planes



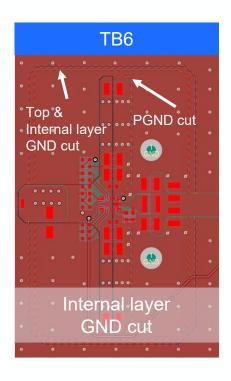
Ground plane splitting: What is the myth about?

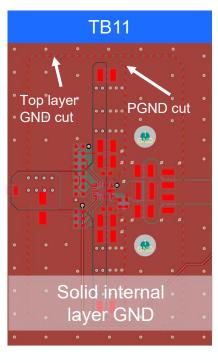
Return currents in the GND plane are mostly concentrated next to their source conductor, but part of them is spread over a wider surface of the plane. These larger current loops form a magnetic antenna and will radiate. By cutting the GND portion of the hot loop from the rest of the board's GND, these current loops are forced to be smaller and thus, the emission will be lower.

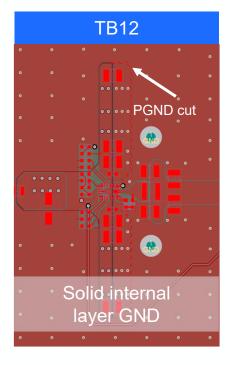


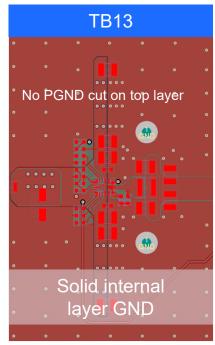


Ground plane splitting: How was it tested?





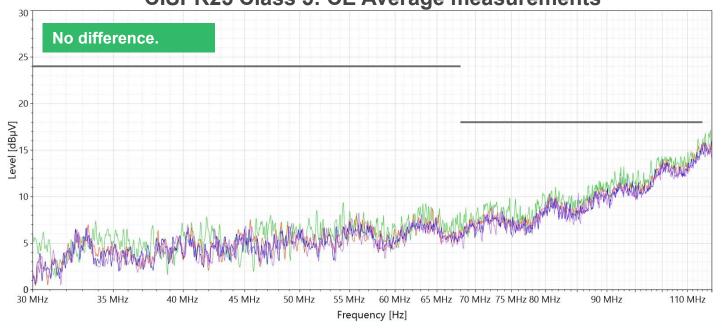






Ground plane splitting: Test results





TB6: All GND cuts

TB11: Removing Internal GND cut

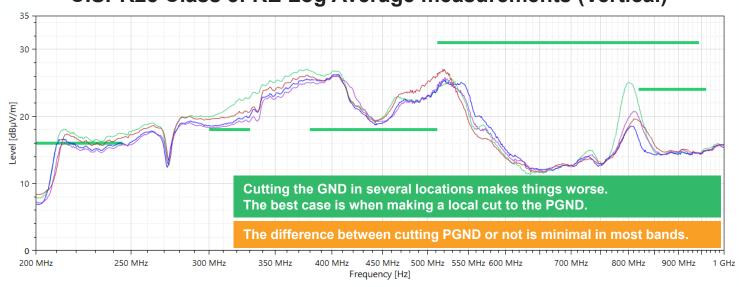
TB12: Removing Internal and Top GND cut

TB13: Removing all cuts



Ground plane splitting: Test results

CISPR25 Class 5: RE Log Average measurements (Vertical)



TB6: All GND cuts

TB11: Removing Internal GND cut

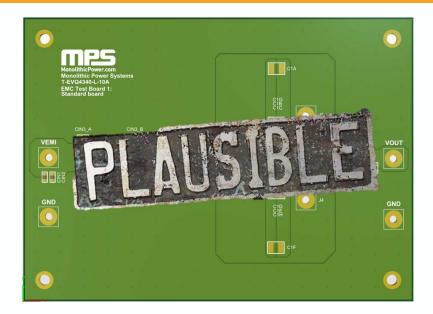
TB12: Removing Internal and Top GND cut

TB13: Removing all cuts



Ground plane splitting: Mythbusting

- Splitting the GND plane in the power converter circuit does not have a significant impact on EMI (<1 dB μ V/m).
- When Cutting the GND plane in multiple areas, placing Vias as much as possible to reduce the influence of parasitic parameter.





Myth EMC Techniques

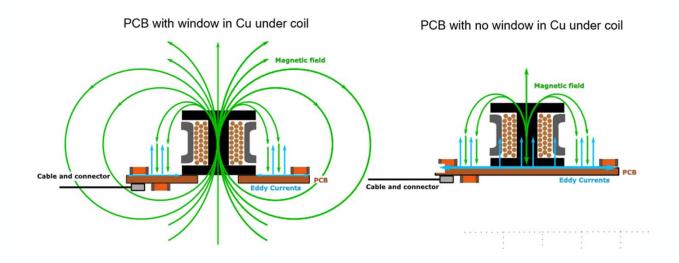
Having copper under the inductor



Copper under the inductor: What is the myth about?

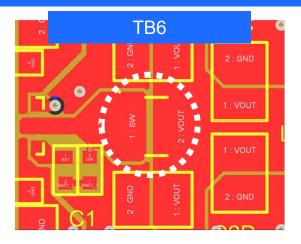
The magnetic fields emitted by the inductor create eddy currents when they hit perpendicular to a conductor.

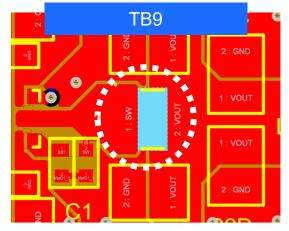
These eddy currents create losses in the form of heat and reduce the effective inductance. However, the eddy currents also generate magnetic fields which oppose the inductor's one. By placing copper under the inductor, most magnetic field is captured and converted to eddy currents so the emissions are lower.

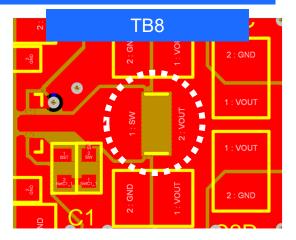


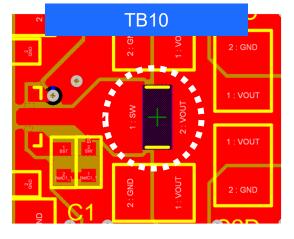


Copper under the inductor: How was it tested?



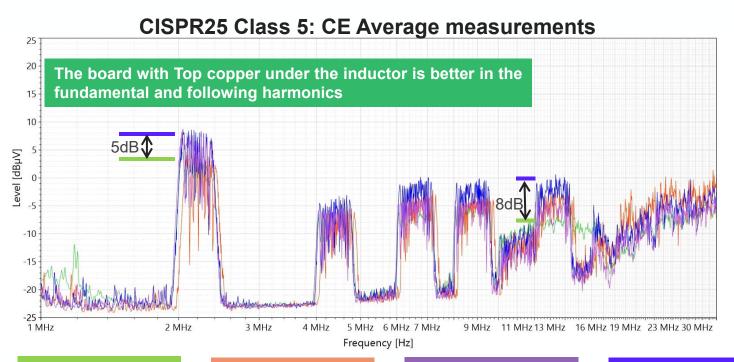








Copper under the inductor: Test results



TB6: Copper under L

TB8: Removing Top copper

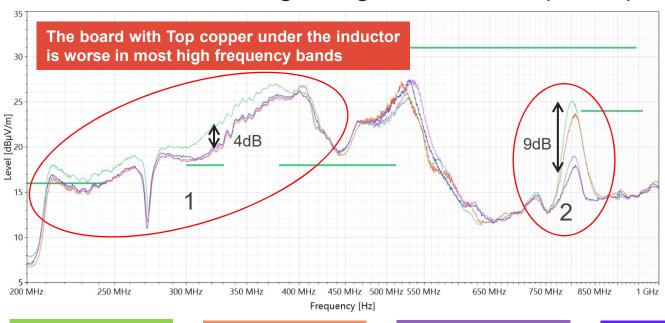
TB9: Removing Internal and Top copper

TB10: Removing all copper



Copper under the inductor: Test results

CISPR25 Class 5: RE Log Average measurements (Vertical)



TB6: Copper under L

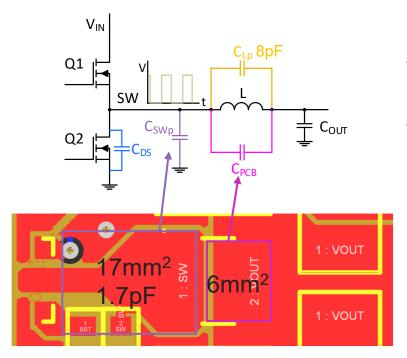
TB8: Removing Top copper

TB9: Removing Internal and Top copper

TB10: Removing all copper



Copper under the inductor: Analysis



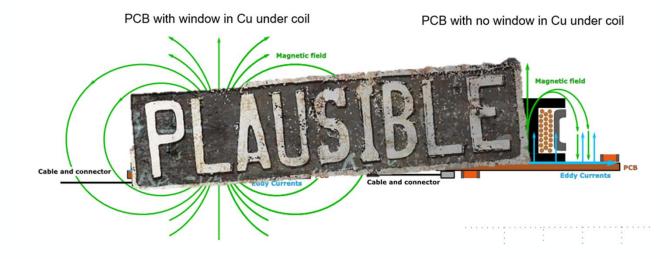
The copper area under the inductor in top layer is Vout. The eddy currents are induced there. The Parasitic Capacitance between SW and Vout is increased by this extra area.



Copper under the inductor: Mythbusting

The test results in CE show a reduction in the emitted noise when having copper directly under the inductor.

The test results in RE show an increase in the emitted noise when having copper directly under the inductor. This may be caused by the copper being Vout instead of GND.





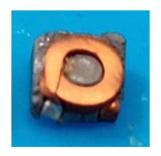
Myth EMC Techniques

Shielded inductors



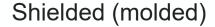
Shielded inductors: What is the myth about?

Shielded inductors are regarded as to always have better EMI performance compared to non-shielded or *semi-shielded inductors*.



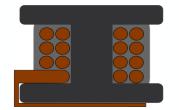












Semi-Shielded (epoxy coating)



Shielded inductors: How was it tested?

Changed the standard molded inductor used in all other test MPL-AY4020-1R0 to the semi-shielded MPL-SE4030-1R0



APPLICATIONS

- · Battery-powered devices
- · Embedded computing
- High-current SMPS

Resonance Frequency

- High-frequency SMPS
- POL converters
- FPGA



APPLICATIONS

- · Battery-powered devices
- High-efficiency SMPS
- · Embedded computing
- Input filters

FEATURES

- Size 4.1mmx4.1mmx1.9mm
- Low DCR
- Low AC Losses
- Low Audible Noise
- Molded Construction Soft Saturation
- Stable Over High Temperatures
- Max Operating Temp +155°C RoHS/REACH-Compliant, Halogen-Free

Parameter			Value
Inductance (1)	L	±20%	1.0
Resistance	Roc	typ	10.1
Resistance MAX	RDC MAX	max	11.8
Rated Current (2)	IR	typ	7.9
Saturation Current 25°C (3)	ISAT 25°C	typ	8.6
Saturation Current 100°C (4)	ISAT 100°C	typ	8.6

Cp=8pF

mΩ

mΩ

Α

FEATURES

- Size 4mmx4mmx3mm
- Semi-Shielded Construction
- Low Stray Field
- Max Operating Temp +125°C
- RoHS/REACH-Compliant, Halogen-Free

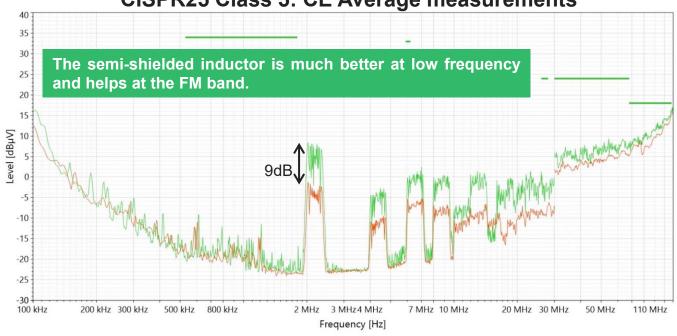
ELECTRICAL CHARACTERISTICS							
Parameter			Value	Unit			
Inductance (1)	L	±20%	1.0	μH			
Resistance	Roc	typ	12.5	mΩ			
Resistance MAX	RDC MAX	max	15	mΩ			
Rated Current (2)	I R	typ	6.3	Α			
Saturation Current 25°C (3)	ISAT 25°C	typ	7.5	Α			
Saturation Current 100°C (4)	ISAT 100°C	typ	7.2	Α			
Resonance Frequency	fr	typ	90	MHz			

Cp=3pF



Shielded inductors: Test results

CISPR25 Class 5: CE Average measurements



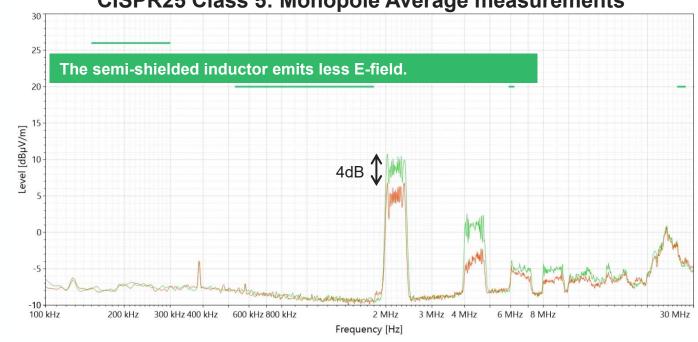
TB6: Molded Inductor

TB15: Semi-Shielded Inductor



Shielded inductors: Test results

CISPR25 Class 5: Monopole Average measurements

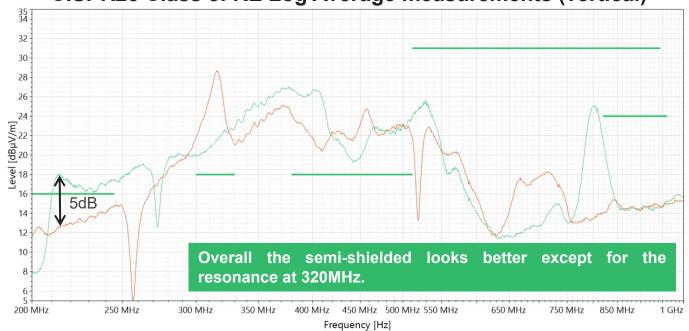


TB15: Semi-Shielded



Shielded inductors: Test results

CISPR25 Class 5: RE Log Average measurements (vertical)



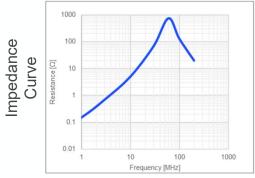
TB6: Molded Inductor

TB15: Semi-Shielded Inductor

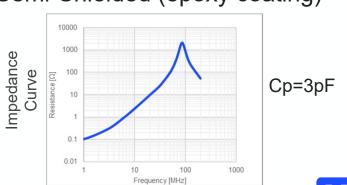


Shielded inductors: Analysis





Cp=8pF



Shielded inductors: Mythbusting

From previous experience, it is true that in some cases shielded inductors improve the EMC results.

In this particular test, the shielded inductor exhibits worse EMI than the semi-shielded. This is due to the construction of the inductor.

Each design is unique, you have to test in the early stages and evaluate which components are best. Not all inductors are built equal.



Lower radiation

Credit. Christian Kueck

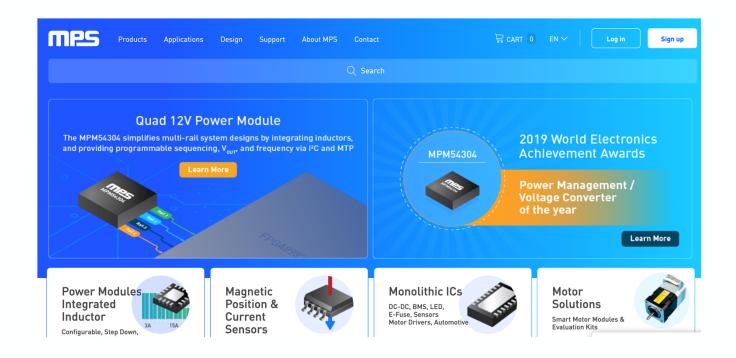


Conclusions

- Many EMC recommendations given in seminars are not valid across all designs.
 There are several variables at play (PCB size, load type, harnesses...).
- The way to ensure if a design is going in the right direction is through testing in the early stages of development.
- Start the design following the typical EMC good practices like symmetrical input capacitance, adding a 100nF capacitor, choosing a good inductor...
- Test the initial design and see what are its shortcomings. Then come up with a plan to fix the issues in the identified frequencies.
- Execute the improvement plan, then repeat the testing to check if the new system is on the right track.



Q&A



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